



MAIL STOP
AMENDMENT

UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J.-S. Mok et al.

Attorney Docket No.: LEPA121687

Application No.: 10/677,182

Art Unit: 1765 / Confirmation No.: 8329

Filed: October 2, 2003

Examiner: S. Ahmed

Title: METHOD OF FORMING SOLDER RESIST PATTERN

AMENDMENT TRANSMITTAL LETTER

Seattle, Washington 98101

June 8, 2006

TO THE COMMISSIONER FOR PATENTS:

A. Amendment Transmittal

Transmitted herewith is an amendment in the above-identified application.

X 1. The claim fee has been calculated as shown below.

COMPUTATION OF FEE FOR CLAIMS AS AMENDED

	Claims Remaining After Amendment	Highest Number Previously Paid For	Present Extra	Rate	Additional Fee
Total Claims	21	-	20	= 1 x 50 =	50
Independent Claims	6	-	3	= 3 x 200 =	600
TOTAL					\$650

B. Fees Enclosed

Enclosed is our Check No. 170843 in the amount of \$650 to cover the amendment claim fee.

C. Additional Fee Charges or Credit for Overpayment

The Commissioner is hereby authorized to charge any fees under 37 C.F.R. §§ 1.16, 1.17

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Seattle, Washington 98101
206.682.8100

and 1.18 which may be required during the entire pendency of the application, or credit any overpayment, to Deposit Account No. 03-1740. A copy of this document is enclosed.

Respectfully submitted,

CHRISTENSEN O'CONNOR
JOHNSON KINDNESS^{PLLC}



Laura A. Cruz
Registration No. 46,649
Direct Dial No. 206.695.1725

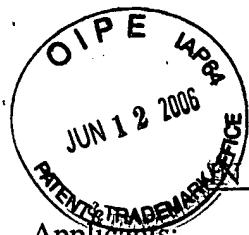
I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first class mail with postage thereon fully prepaid and addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the below date.

Date: June 8, 2006

LXC:dlw



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TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

Please amend the above-identified application as follows.

06/13/2006 CCHAU1 00000013 10677182

01 FC:1202 50.00 OP
02 FC:1201 600.00 OP

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